

STS15N4LLF3

N-channel 40V - 0.0042Ω - 15A - SO-8 STripFET™ Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS15N4LLF3	40V	<0.005Ω	15A

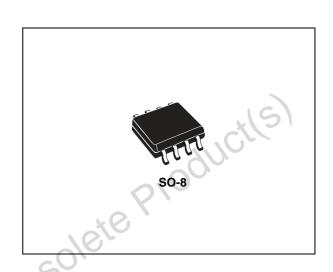
- lacktriangle Optimal $R_{DS(on)}x$ Q_g trade-off @ 4.5V
- Conduction losses reduced
- Switching losses reduced

Description

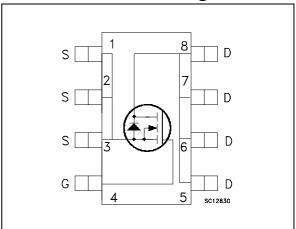
This N-channel enhancement mode Power MOSFET is the latest refinement of STMicroelectronic unique "Single Feature Size™" strip-based process with less critical aligment steps and therefore a remarkable manufacturing reproducibility. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and low gate charge.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STS15N4LLF3	15N4LL-	SO-8	Tape & reel

Contents STS15N4LLF3

Contents

1	Electrical ratings 3
2	Electrical characteristics 4 2.1 Electrical characteristics (curves) 6
3	Test circuit 8
4	Package mechanical data9
5	Revision history11
005	Electrical characteristics

STS15N4LLF3 **Electrical ratings**

Electrical ratings 1

Table 1. **Absolute maximim ratings**

Symbol	Parameter	Value	Unit			
V _{DS}	Drain-source voltage (V _{GS} = 0)	40	٧			
V _{GS}	Gate-source voltage ± 16					
V _{GS} ⁽¹⁾	Gate- source voltage	±18	٧			
I _D	Drain current (continuous) at T _C = 25°C 15		Α			
I _D	Drain current (continuous) at T _C = 100°C	9.3	Α			
I _{DM} ⁽²⁾	Drain current (pulsed) 60					
P _{TOT}	Total dissipation at T _C = 25°C	2.7	W			
E _{AS} (3)	Single pulse avalanche energy	2	J			
1. Guarante	ed for test time ≤ 15ms	010				
2. Pulse wid	Ith limited by Tjmax					
3. Starting $T_j = 25^{\circ}\text{C}$, $I_D = 7.5\text{A}$, $V_{DD} = 25\text{V}$						
Table 2.	Table 2. Thermal resistance					
Symbol	Parameter	Value	Unit			

- 1. Guaranteed for test time ≤ 15ms
- 2. Pulse width limited by Tjmax
- 3. Starting $T_i = 25$ °C, $I_D = 7.5$ A, $V_{DD} = 25$ V

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj} -pcb ⁽¹⁾	Thermal resistance junction-pcb max	47	°C/W
T _I	Maximum lead temperature for soldering	-55 to 150	°C
T _{stg}	Storage temperature	-55 to 150	°C

ed of Fig. 1. When mounted of FR-4 board with 1 inch 2 pad, 2oz of Cu and t< 10sec

Electrical characteristics STS15N4LLF3

2 Electrical characteristics

 $(T_J = 25 \, ^{\circ}C \text{ unless otherwise specified})$

Table 3. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	40			٧
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = max rating, V _{DS} =max rating @ 125°C			10 100	μ Α μ Α
I _{GSS}	Gate body leakage Current (V _{DS} = 0)	V _{GS} = ±16V		(±200	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	6		٧
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10V, I_D = 7.5A V_{GS} = 4.5V, I_D = 7.5A	210	0.0042 0.005	0.005 0.007	Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25V, f=1 MHz, V _{GS} = 0		2530 574 29		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 20V, I_D = 15A V_{GS} = 4.5V (see Figure 13)		21.5 6.9 8.2	28	nC nC nC
R_G	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20mV open drain	1	3	5	Ω

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} = 20V, I_D = 7.5A, R_G = 4.7 Ω , V_{GS} = 10V (see Figure 15)		17 25		ns ns
t _{d(off)} t _f	Turn-off delay time Fall time	V_{DD} = 20V, I_D = 7.5A, R_G = 4.7 Ω , V_{GS} = 10V (see Figure 15)		62 9		ns ns

4/12

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current				15	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				60	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 15A, V_{GS} = 0$			1.2	V
t _{rr}	Reverse recovery time	$I_{SD} = 15A, V_{DD} = 30V,$		43		ns
Q _{rr}	Reverse recovery charge	di/dt = 100A/μs,		64		nC
I _{RRM}	Reverse recovery current	Tj = 150°C (see Figure 14)		3		Α
1. Pulse widt	th limited by safe operating area					
		0	00	70.		
		usolete '				
	ct(6)	obsolete !				
P	oduct(s)	obsolete !				
ie P'	oduci(s)	josoleite !				
te P	Heverse recovery current th limited by safe operating area alse duration = 300µs, duty cycle 1.5	josolete !				

Electrical characteristics STS15N4LLF3

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

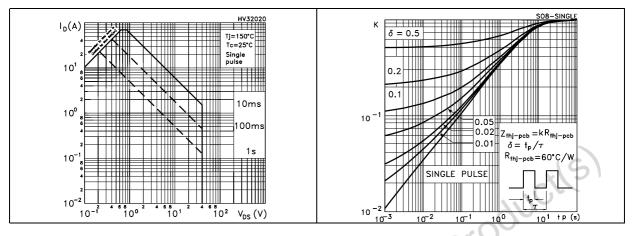


Figure 3. Output characterisics

Figure 4. Transfer characteristics

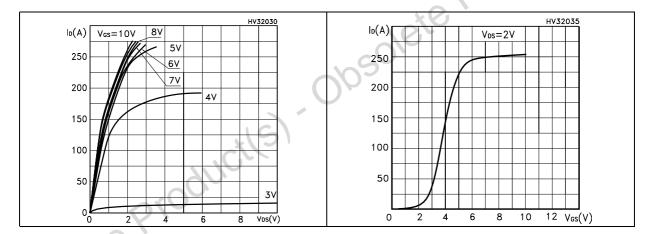
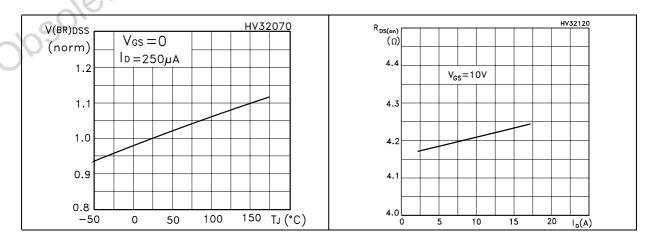


Figure 5. Normalized B_{VDSS} vs temperature

Figure 6. Static drain-source on resistance



6/12

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

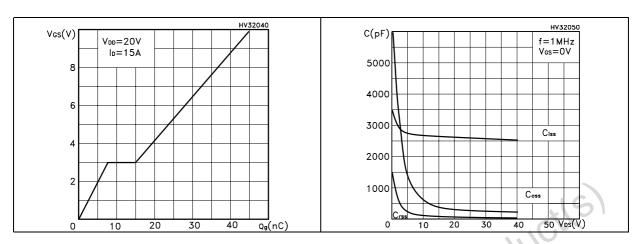


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

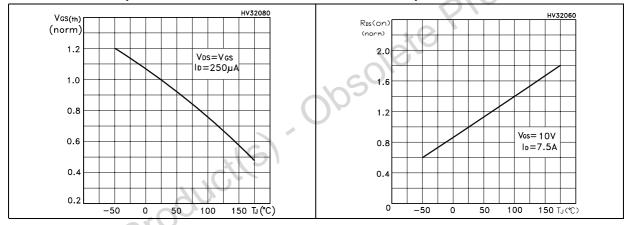
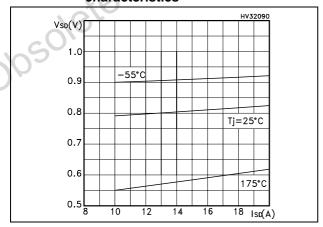


Figure 11. Source-drain diode forward characteristics



Test circuit STS15N4LLF3

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

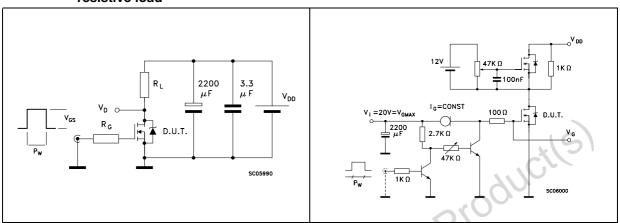


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

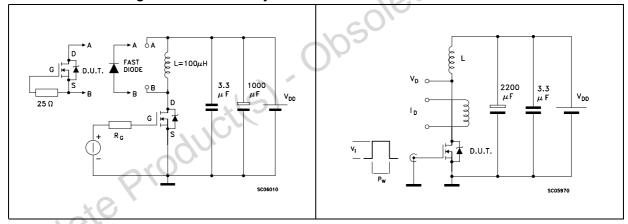
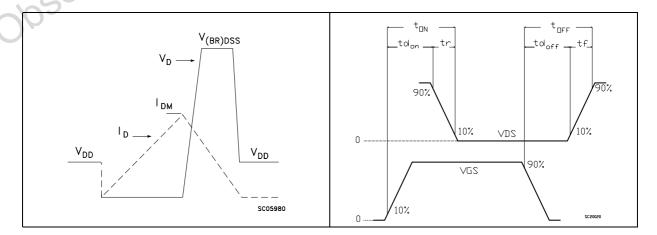


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



4 Package mechanical data

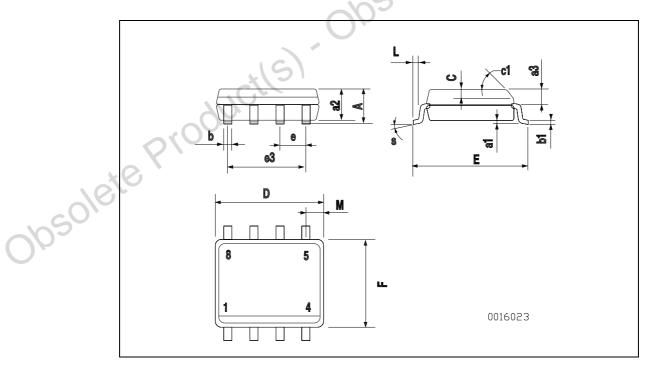
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: twww.st.com

9/12

Obsolete Product(s).

SO-8 MECHANICAL DATA

	mm.			inch	
MIN.	TYP	MAX.	MIN.	TYP.	MAX.
		1.75			0.068
0.1		0.25	0.003		0.009
		1.65			0.064
0.65		0.85	0.025		0.033
0.35		0.48	0.013		0.018
0.19		0.25	0.007		0.010
0.25		0.5	0.010		0.019
		45	(typ.)		16
4.8		5.0	0.188		0.196
5.8		6.2	0.228	(0.244
	1.27			0.050	
	3.81			0.150	
3.8		4.0	0.14		0.157
0.4		1.27	0.015		0.050
		0.6	*6		0.023
	•	1) 8	max.)		•
	0.1 0.65 0.35 0.19 0.25 4.8 5.8	MIN. TYP 0.1 0.65 0.35 0.19 0.25 4.8 5.8 1.27 3.81 3.8	MIN. TYP MAX. 1.75 1.75 0.1 0.25 1.65 0.85 0.35 0.48 0.19 0.25 0.25 0.5 45 4.8 5.8 6.2 1.27 3.81 3.8 4.0 0.4 1.27 0.6 0.6	MIN. TYP MAX. MIN. 1.75 0.003 1.65 0.025 0.003 0.65 0.85 0.025 0.35 0.48 0.013 0.19 0.25 0.007 0.25 0.5 0.010 45 (typ.) 4.8 5.0 0.188 5.8 6.2 0.228 1.27 3.81 3.8 4.0 0.14 0.4 1.27 0.015	MIN. TYP MAX. MIN. TYP. 0.1 0.25 0.003 1.65 0.85 0.025 0.35 0.48 0.013 0.19 0.25 0.007 0.25 0.010 45 (typ.) 4.8 5.0 0.188 5.8 6.2 0.228 1.27 0.050 3.81 4.0 0.14 0.4 1.27 0.015 0.6 0.6 0.6



STS15N4LLF3 Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Jun-2006	1	First release
22-Nov-2006	2	Corrected part number

Obsolete Product(s). Obsolete Product(s)

11/12

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com